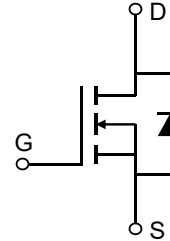


Description

Features

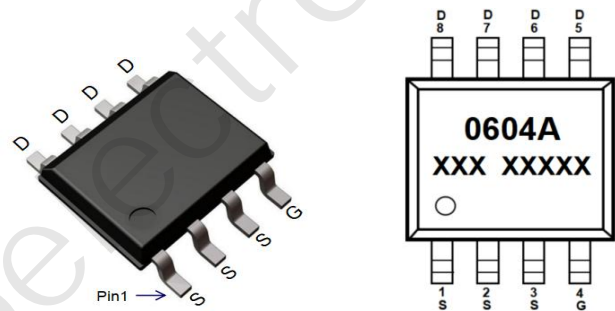
- 60V, 20A
- $R_{DS(ON)}$ Typ = 4.7mΩ @ $V_{GS} = 10V$
- $R_{DS(ON)}$ Typ = 5.8mΩ @ $V_{GS} = 4.5V$
- Advanced Split Gate Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free
- 100% UIS TESTED!



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

| Device | Marking | Package | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|-------------|---------|---------|---------|-----------|------------|------------------|
| CRMPGL0604A | 0604A | SOP-8 | TAPING | 13" | 4000 | 40000 |

Absolute Maximum Ratings (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | Units | |
|-----------------------------------|--|------------------------|-------|---|
| V _{DS} | Drain-to-Source Voltage | 60 | V | |
| V _{GS} | Gate-to-Source Voltage | ±20 | V | |
| I _D | Continuous Drain Current | T _A = 25°C | 20 | A |
| | | T _A = 100°C | 12 | A |
| I _{DM} | Pulsed Drain Current ⁽¹⁾ | 80 | A | |
| E _{AS} | Single Pulsed Avalanche Energy ⁽²⁾ | 110 | mJ | |
| P _D | Power Dissipation | T _A = 25°C | 4.2 | W |
| R _{θJA} | Thermal Resistance, Junction to Ambient ⁽³⁾ | 30 | °C/W | |
| T _J , T _{STG} | Junction & Storage Temperature Range | -55 to 150 | °C | |

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|------------|------|------|------|------|
|--------|-----------|------------|------|------|------|------|

Off Characteristics

| | | | | | | |
|---------------|---------------------------------|--|----|---|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | $I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$ | 60 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 60\text{V}$, $V_{GS} = 0\text{V}$ | - | - | 1.0 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{DS} = 0\text{V}$, $V_{GS} = \pm 20\text{V}$ | - | - | ± 100 | nA |

On Characteristics

| | | | | | | |
|--------------|--|---|-----|-----|-----|----|
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$ | 1.2 | 1.6 | 2.5 | V |
| $R_{DS(ON)}$ | Static Drain-Source ON-Resistance ⁽⁴⁾ | $V_{GS} = 10\text{V}$, $I_D = 20\text{A}$ | - | 4.7 | 6.1 | mΩ |
| | | $V_{GS} = 4.5\text{V}$, $I_D = 10\text{A}$ | - | 5.8 | 7.5 | mΩ |

Dynamic Characteristics

| | | | | | | |
|-----------|------------------------------|--|---|------|---|----|
| C_{iss} | Input Capacitance | $V_{GS} = 0\text{V}$, $V_{DS} = 30\text{V}$, $f = 1\text{MHz}$ | - | 1960 | - | pF |
| C_{oss} | Output Capacitance | | - | 650 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 29 | - | pF |
| Q_g | Total Gate Charge | $V_{GS} = 0$ to 10V $V_{DS} = 30\text{V}$, $I_D = 20\text{A}$ | - | 35 | - | nC |
| Q_{gs} | Gate Source Charge | | - | 10 | - | nC |
| Q_{gd} | Gate Drain("Miller") Charge | | - | 7 | - | nC |

Switching Characteristics

| | | | | | | |
|--------------|--------------------|---|---|----|---|----|
| $t_{d(on)}$ | Turn-On DelayTime | $V_{GS} = 10\text{V}$, $V_{DD} = 30\text{V}$ $I_D = 20\text{A}$, $R_{GEN} = 4.5\Omega$ | - | 12 | - | ns |
| t_r | Turn-On Rise Time | | - | 34 | - | ns |
| $t_{d(off)}$ | Turn-Off DelayTime | | - | 25 | - | ns |
| t_f | Turn-Off Fall Time | | - | 30 | - | ns |

Drain-Source Diode Characteristics and Max Ratings

| | | | | | | |
|----------|--|---|---|----|-----|----|
| I_S | Maximum Continuous Drain to Source Diode Forward Current | $V_{GS} = 0\text{V}$, $I_S = 30\text{A}$ | - | - | 20 | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 80 | A |
| V_{SD} | Drain to Source Diode Forward Voltage | | - | - | 1.2 | V |
| t_{rr} | Body Diode Reverse Recovery Time | | - | 38 | - | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | | - | 23 | - | nC |

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
 2. E_{AS} condition: Starting $T_J = 25^\circ\text{C}$, $V_{DD} = 30\text{V}$, $V_G = 10\text{V}$, $R_G = 25\Omega$, $L = 0.5\text{mH}$, $I_{AS} = 21\text{A}$
 3. $R_{\theta JA}$ is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB
 4. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.

Test Circuit



Figure 1: Gate Charge Test Circuit & Waveform



Figure 2: Resistive Switching Test Circuit & Waveform

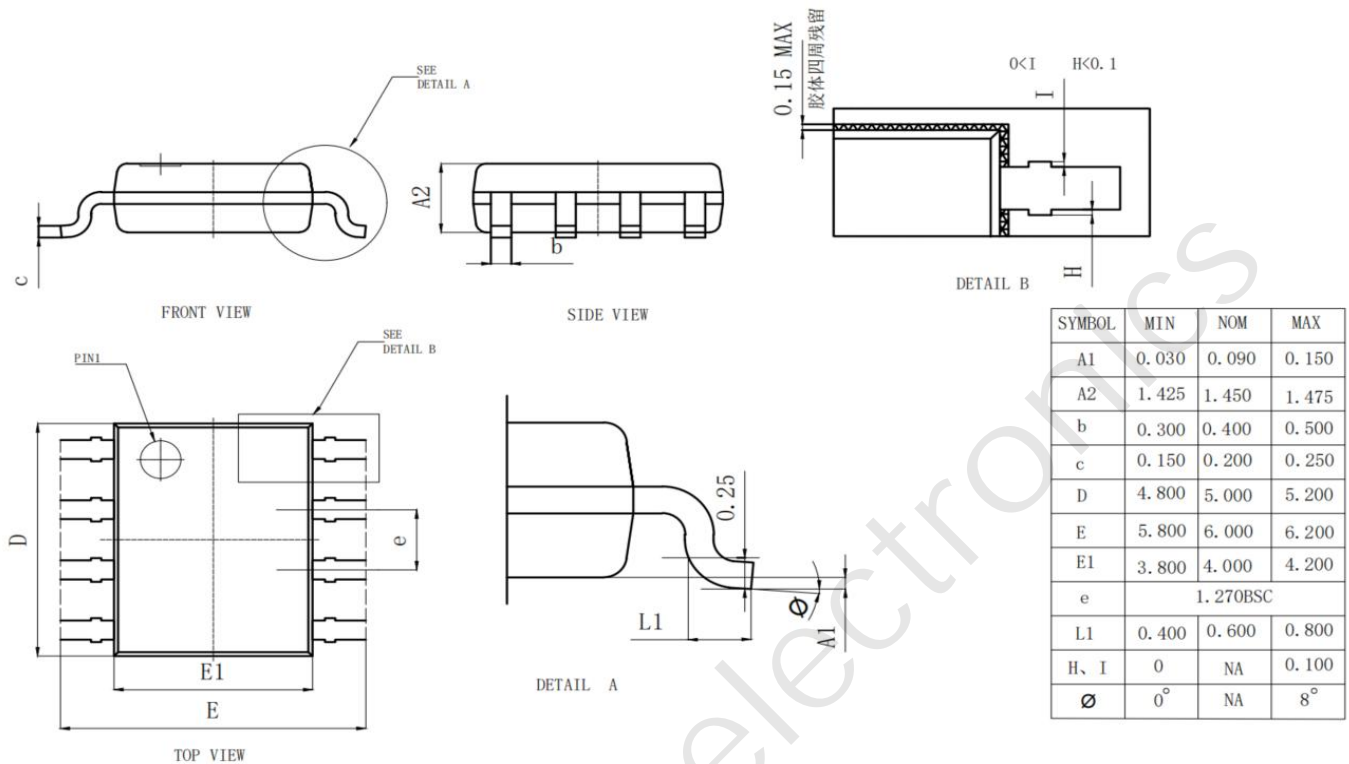


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform



Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(SOP-8)



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